

# PolarHT™HiPerFET IXFK 140N20P **Power MOSFET**

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

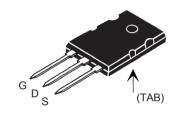


<b>V</b> <sub>DSS</sub>	=	200	V
  D25	=	140	Α
R <sub>DS(on)</sub>	≤	18	$m\Omega$
t <sub>rr</sub>	≤	200	ns

Symbol	Test Conditions	Maximum Ratings			
V <sub>DSS</sub> V <sub>DGR</sub>	$T_J = 25^{\circ}$ C to 175° C $T_J = 25^{\circ}$ C to 175° C; $R_{GS} = 1$ MΩ	200 200	V		
V <sub>GS</sub> V <sub>GSM</sub>	Continous Transient	±20 ±30	V		
I <sub>D25</sub>	T <sub>C</sub> = 25° C	140	Α		
I <sub>D(RMS)</sub>	External lead current limit	75	Α		
I <sub>DM</sub>	$T_{\rm C}$ = 25° C, pulse width limited by $T_{\rm JM}$	280	Α		
I <sub>AR</sub>	T <sub>C</sub> =25°C	60	Α		
E <sub>AR</sub>	T <sub>C</sub> = 25° C	100	mJ		
E <sub>AS</sub>	T <sub>C</sub> = 25° C	4	J		
dv/dt	$I_{S} \leq I_{DM}$ , di/dt $\leq 100$ A/ $\mu$ s, $V_{DD} \leq V_{DSS}$ , $T_{J} \leq 150^{\circ}$ C, $R_{G} = 4$ $\Omega$	10	V/ns		
P <sub>D</sub>	T <sub>C</sub> = 25° C	830	W		
T <sub>J</sub> T <sub>JM</sub> T <sub>stg</sub>		-55 +175 175 -55 +150	°C °C °C		
T <sub>L</sub> T <sub>SOLD</sub>	1.6 mm (0.062 in.) from case for 10 s Plastic body for 10 s	300 260	°C		
M <sub>d</sub>	Mounting torque	1.13/10	Nm/lb.in.		
Weight		10	g		
Symbol Test Conditions Characteristic Value (T = 25° C unless otherwise specified) Min   Tyn   Max					

			aracteristic Values   Typ.   Max.			
BV <sub>DSS</sub>	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		200			V
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 4 \text{ mA}$		2.5		5.0	V
I <sub>GSS</sub>	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$				±200	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	T <sub>J</sub> = 150° C			25 250	μA μA
R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_{D} = 0.5 I_{D25}$ $V_{GS} = 15 \text{ V}, I_{D} = 140 \text{A}$ Pulse test, t \( \le 300 \text{ \mu} \text{s}, \text{ duty}	cycle d ≤ 2 %		14	18	mΩ

## TO-264 (IXFK)



G = Gate D = Drain TAB = Drain S = Source

### **Features**

- <sup>1</sup> International standard package
- Unclamped Inductive Switching (UIS) rated
- 1 Low package inductance
  - easy to drive and to protect

### **Advantages**

- <sup>1</sup> Easy to mount
- Space savings
- <sup>1</sup> High power density

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Symbo	ol	Test Conditions $(T_{_{J}} = 25^{\circ}C,un$ Min	less		ristic Values ise specified)  Max.
$g_{fs}$		$V_{DS}$ = 10 V; $I_{D}$ = 0.5 $I_{D25}$ , pulse test	0	84	S
$\mathbf{C}_{iss}$	)			7500	pF
$\mathbf{C}_{oss}$	}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1800	pF
C <sub>rss</sub>	J			280	pF
t <sub>d(on)</sub>	)			30	ns
t <sub>r</sub>		$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{D} = 60 \text{ A}$		35	ns
$\mathbf{t}_{d(off)}$		$R_{_{\rm G}}$ = 3.3 $\Omega$ (External)		150	ns
t <sub>f</sub>				90	ns
$\mathbf{Q}_{\mathrm{g(on)}}$	)			240	nC
$\mathbf{Q}_{gs}$	}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 0.5 I_{D25}$		50	nC
$\mathbf{Q}_{gd}$	J			100	nC
$\mathbf{R}_{thJC}$					0.18° C/W
R <sub>thCS</sub>				0.15	° C/W

### Source-Drain Diode

Characteristic Values (T, = 25°C, unless otherwise specified)

Symbo	ol	Test Conditions M	in.	Тур.	Max.	
Is		$V_{GS} = 0 V$			140	Α
I <sub>sm</sub>		Repetitive			280	Α
V <sub>SD</sub>		$I_F = I_S$ , $V_{GS} = 0 \text{ V}$ , Pulse test, t ≤300 µs, duty cycle d≤ 2 %			1.5	V
t <sub>rr</sub>	}	I <sub>F</sub> = 25 A -di/dt = 100 A/μs		120	200	ns
$\mathbf{Q}_{RM}$	J	V <sub>R</sub> = 100 V, V <sub>GS</sub> = 0 V		3.5		μC

# TO-264 (IXFK) Outline 1 - GATE 2, 4 - DRAIN (COLLECTOR) 3 - SOURCE (EMITTER) SYM MIN MAX MIN MAX A .185 .209 4.70 5.31 A1 .102 .118 2.59 3.00 b .037 .055 0.94 1.40 b1 .087 .102 2.21 2.59 b2 .110 .126 2.79 3.20 c .017 .029 0.43 0.74 D 1.007 1.047 25.58 26.59 E .760 .799 19.30 20.29 e .21585C 5.46 8BSC J .000 .010 0.00 0.25 K .000 .010 0.00 0.25 C .779 .842 19.79 21.39 L 1 .087 102 2.21 2.59 ØP .122 .138 3.10 3.51 Q .240 .256 6.10 6.50 Q 1 .330 .346 8.38 8.79 ØR .155 1.87 3.94 4.75



Fig. 1. Output Characteristics

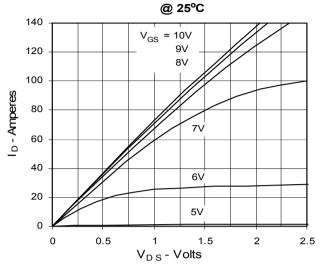


Fig. 3. Output Characteristics

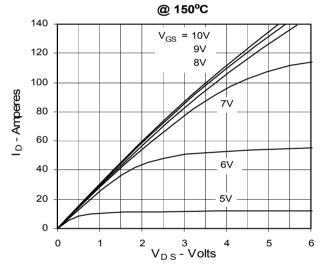


Fig. 5.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs. Drain Current

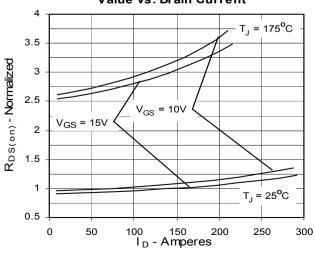


Fig. 2. Extended Output Characteristics

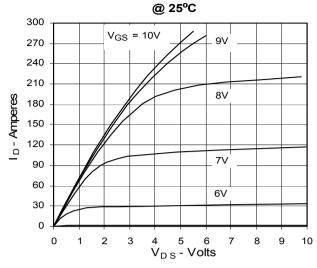


Fig. 4.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs. Junction Temperature

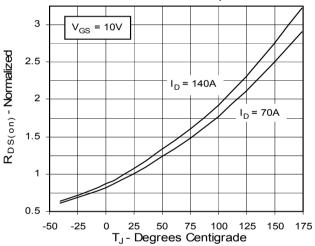
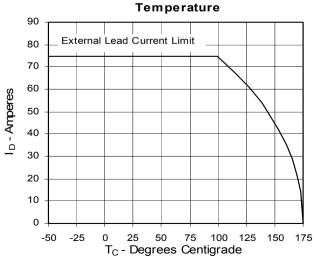
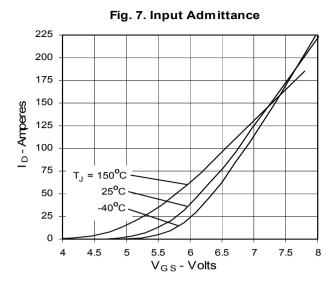
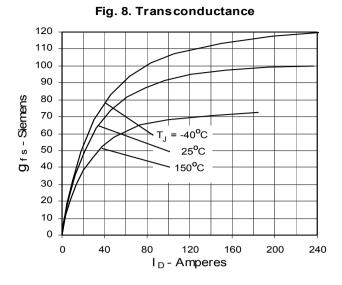


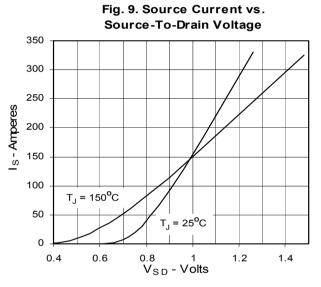
Fig. 6. Drain Current vs. Case

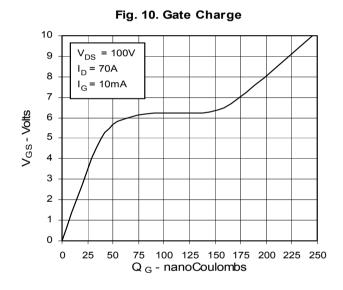


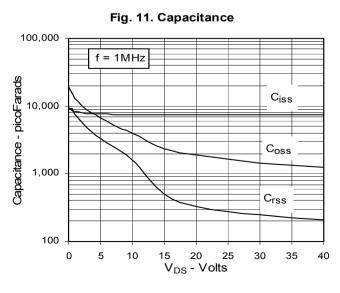


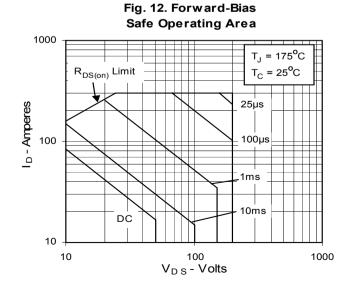












IXYS reserves the right to change limits, test conditions, and dimensions.



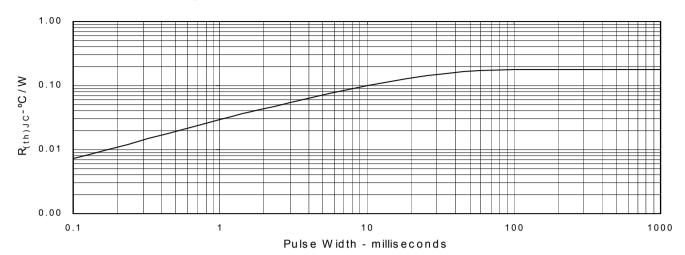


Fig. 13. Maximum Transient Thermal Resistance

